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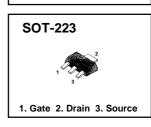
IEEE802.3af Compatible

- □ Avalanche Rugged Technology
- □ Rugged Gate Oxide Technology
- □ Lower Input Capacitance
- □ Improved Gate Charge

FEATURES

- D Extended Safe Operating Area
- □ Lower Leakage Current : 10 μ A (Max.) @ V_{DS} = 100V
- $\hfill\square$ Lower $R_{DS(ON)}$: 0.155 Ω (Typ.)

 $BV_{DSS} = 100 V$ $R_{DS(on)} = 0.2 \Omega$ $I_{D} = 2.3 A$



Symbol	Characteristic	Value	Units	
V _{DSS}	Drain-to-Source Voltage	100	V	
Ι _D	Continuous Drain Current (T _A =25°C)	2.3		
	Continuous Drain Current (T _A =70°C)	1.84	A	
I _{DM}	Drain Current-Pulsed (1)	18	А	
V _{GS}	Gate-to-Source Voltage	±20	V	
E _{AS}	Single Pulsed Avalanche Energy 2	123	mJ	
I _{AR}	Avalanche Current (1)	2.3	А	
E _{AR}	Repetitive Avalanche Energy (1)	0.24	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	6.5	V/ns	
P _D	Total Power Dissipation (T _A =25°C) *	2.4	W	
' D	Linear Derating Factor *	0.019	W/℃	
T_J , T_STG	Operating Junction and		- °c	
	Storage Temperature Range	- 55 to +150		
TL	Maximum Lead Temp. for Soldering	000		
	Purposes, 1/8" from case for 5-seconds	300		

Absolute Maximum Ratings

Thermal Resistance

Symbol	Characteristic	Тур.	Max.	Units
R _{eJA}	Junction-to-Ambient *	-	52	°C/W

* When mounted on the minimum pad size recommended (PCB Mount).



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Symbol	Characteristic	Min.	Tvp.	Max.	Units	Test Condition
BV _{DSS}	Drain-Source Breakdown Voltage	100			V	V _{GS} =0V,I _D =250µA
$\Delta BV / \Delta T_J$	Breakdown Voltage Temp. Coeff.		0.12		V/℃	I _D =250µA See Fig 7
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	V _{DS} =5V,I _D =250µA
I _{GSS}	Gate-Source Leakage, Forward			100	nA	V _{GS} =20V
	Gate-Source Leakage, Reverse			-100	IIA	V _{GS} =-20V
I _{DSS}				1		V _{DS} =30V (6)
	Drain-to-Source Leakage Current			10	μA	V _{DS} =100V
				100		V _{DS} =80V,T _A =125℃
R _{DS(on)}	Static Drain-Source			0.2	Ω	V _{GS} =10V,I _D =1.15A ④
DS(on)	On-State Resistance			0.2	0.2	
g _{fs}	Forward Transconductance		3.12		S	V _{DS} =40V,I _D =1.15A ④
C _{iss}	Input Capacitance		370	480		\/0\/\/25\/f_1\/U_7
C _{oss}	Output Capacitance		95	110	pF	V _{GS} =0V,V _{DS} =25V,f =1MHz See Fig 5
C _{rss}	Reverse Transfer Capacitance		38	45		
t _{d(on)}	Turn-On Delay Time		14	40		
t _r	Rise Time		14	40		$V_{DD} = 50V, I_{D} = 9.2A,$
t _{d(off)}	Turn-Off Delay Time		36	90	ns	R _G =18Ω
t _f	Fall Time		28	70		See Fig 13 ④ 5
Q _q	Total Gate Charge		16	22		V _{DS} =80V,V _{GS} =10V,
Q _{as}	Gate-Source Charge		2.7		nC	I _D =9.2A
Q _{gd}	Gate-Drain("Miller") Charge		7.8			See Fig 6 & Fig 12 (4) (5)

Electrical Characteristics (T_A=25 $^\circ C$ unless otherwise specified)

Source-Drain Diode Ratings and Characteristics

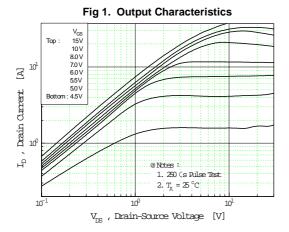
Symbol	Characteristic	Min.	Тур.	Max.	Units	Test Condition
ا _s	Continuous Source Current			2.3	^	Integral reverse pn-diode
I _{SM}	Pulsed-Source Current ①			18	A	in the MOSFET
V _{SD}	Diode Forward Voltage (4)			1.5	V	T _J =25 ℃,I _S =2.3A,V _{GS} =0V
t _{rr}	Reverse Recovery Time		98		ns	T _J =25℃,I _F =9.2A
Q _{rr}	Reverse Recovery Charge		0.34		μC	di _F /dt=100A/µs ④

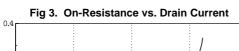
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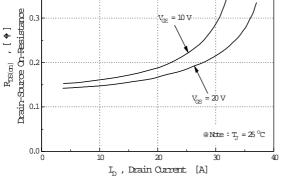
- 1 Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② L=35mH, I_{AS} =2.3A, V_{DD} =25V, R_{G} =27Ω, Starting T_{J} =25°C
- 3 I_{SD}{\leq}9.2A, di/dt{\leq}300A/\mu s, V_{DD}{\leq}BV_{DSS} , Starting T_ =25 \degree
- ④ Pulse Test : Pulse Width = 250μ s, Duty Cycle $\leq 2\%$
- (5) Essentially Independent of Operating Temperature
- 6 Adjusted for Cisco

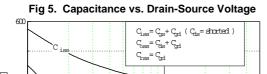


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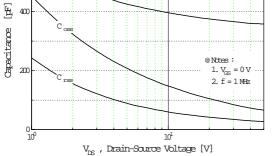




Fig 2. Transfer Characteristics

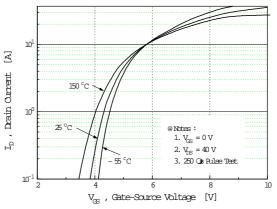
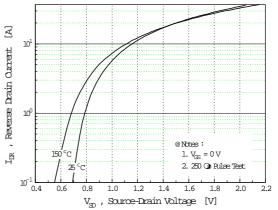
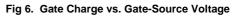
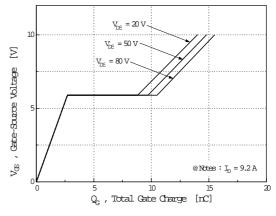
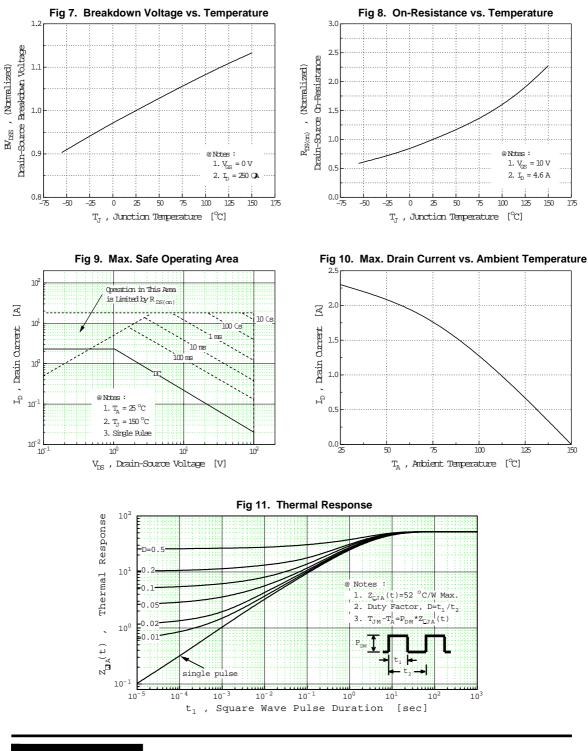


Fig 4. Source-Drain Diode Forward Voltage





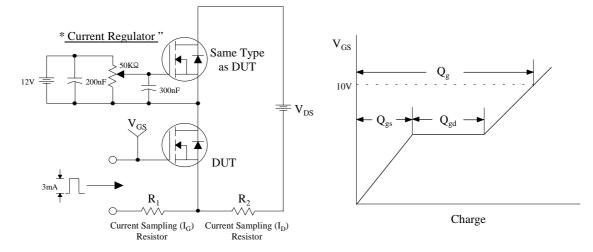






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Fig 12. Gate Charge Test Circuit & Waveform





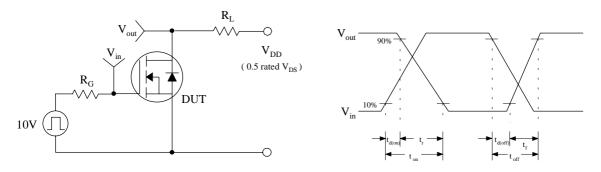
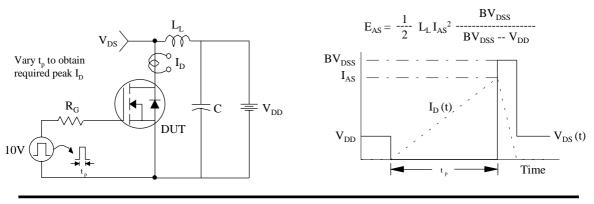


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms





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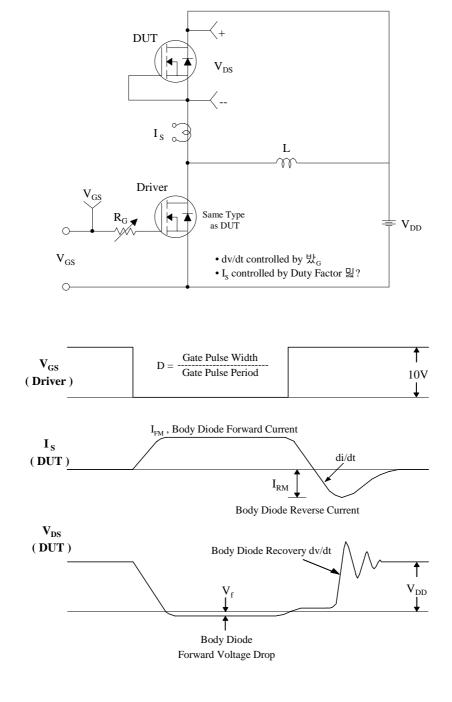
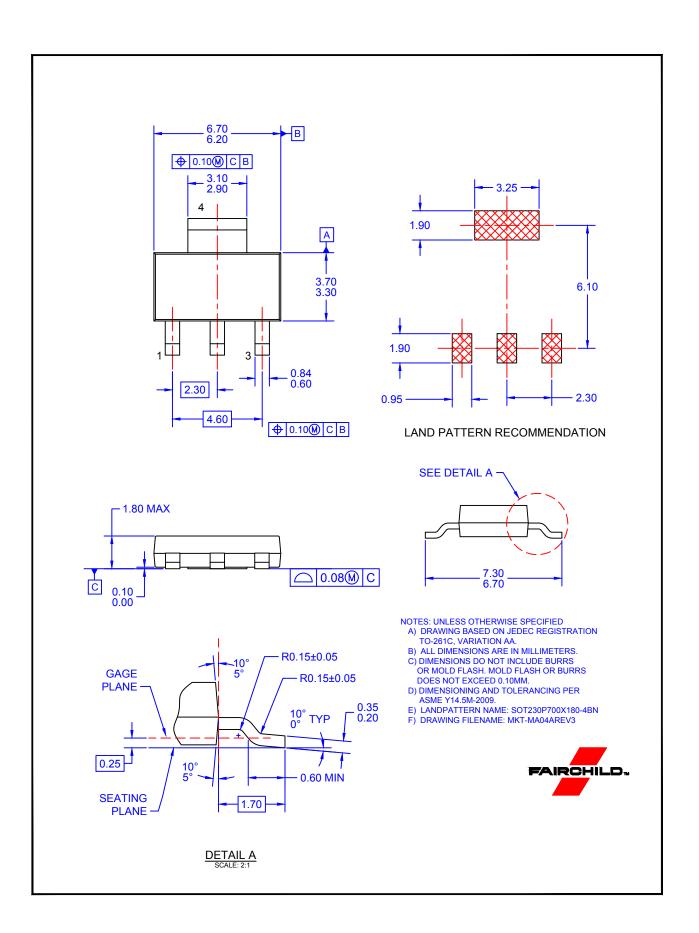


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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